

Docket No. 233813US0

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Reinhard BEUTH, et al.

SERIAL NO: NEW APPLICATION

FILED: HEREWITH

FOR: POLYMERIC OPTICAL CONDUCTORS

**INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97**

ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

SIR:

Applicant(s) wish to disclose the following information.

**REFERENCES**

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references. Reference "AY" is discussed in the specification at page 11, line 22, so this reference is therefore relevant.
- A check is attached in the amount required under 37 CFR §1.17(p).

**RELATED CASES**

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- A check is attached in the amount required under 37 CFR §1.17(p).

**CERTIFICATION**

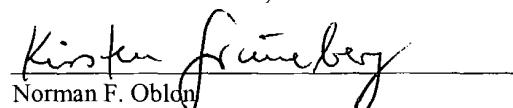
- Each item of information contained in this information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

**DEPOSIT ACCOUNT**

- Please charge any additional fees for the papers being filed herewith and for which no check is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,  
MAIER & NEUSTADT, P.C.

  
Norman F. Oblon  
Registration No. 24,618



22850

Tel. (703) 413-3000  
Fax. (703) 413-2220  
(OSMMN 03/02)

Kirsten A. Grüneberg, Ph.D.  
Registration No. 47,297

Form PTO 1449 (Modified)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY DOCKET NO. 233813US0	SERIAL NO. NEW APPLICATION
LIST OF REFERENCES CITED BY APPLICANT		APPLICANT Reinhard BEUTH, et al.	
		FILING DATE HEREWITH	GROUP

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	4,356,300	10/26/82	ISLER ET AL			
	AB	5,554,426	09/10/96	ROEBER ET AL.			
	AC	5,510,160	04/23/96	JADAMUS ET AL			
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES	NO
	AO	WO 99/12063	03/11/99	WIPO		
	AP	WO 00/60382	10/12/00	WIPO		
	AQ	EP 0 434 244	06/26/91	EUROPE		
	AR	EP 0 296 852	12/28/88	EUROPE		
	AS	EP 0 637 511	02/08/95	EUROPE (W/ENGLISH ABSTRACT)		
	AT	EP 0 673 762	09/27/95	EUROPE (W/ENGLISH ABSTRACT)		
	AU	DE 199 14 743	01/25/01	GERMANY (W/ENGLISH ABSTRACT)		
	AV	DE 30 06 961	08/28/80	GERMANY (W/ENGLISH ABSTRACT)		

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

AW	K. IVIN, et al., "Ring-Opening Polymerization", Elsevier Applied Science Publishers Ltd., vol. 1, pp. 121-190, 1984.
AX	Andreas WEINERT, "Kunststoff-Lichtwellenleiter-Technischer Stand und Entwicklungstrends", pp. 187-190, 1995. (w/Partial English Translation)
AY	A. Dräxler, Kautschuk + Gummi, Kunststoff 1981, pp. 185-190.
AZ	<input type="checkbox"/> Additional References sheet(s) attached
Examiner	Date Considered

\*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.